# **BLC10G22XS-400AVT**

# Power LDMOS transistor

**AMPLEON** 

Rev. 1 — 30 April 2018

**Product data sheet** 

# 1. Product profile

### 1.1 General description

400 W LDMOS packaged asymmetric Doherty power transistor for base station applications at frequencies from 2110 MHz to 2200 MHz.

#### Table 1. Typical performance

Typical RF performance at  $T_{case}$  = 25 °C in an asymmetrical Doherty production test circuit.  $V_{DS}$  = 28 V;  $I_{Dq}$  = 800 mA (main);  $V_{GS(amp)peak}$  = 1.0 V, unless otherwise specified.

| Test signal      | f            | V <sub>DS</sub> | P <sub>L(AV)</sub> | G <sub>p</sub> | η <sub>D</sub> | ACPR                 |
|------------------|--------------|-----------------|--------------------|----------------|----------------|----------------------|
|                  | (MHz)        | (V)             | (W)                | (dB)           | (%)            | (dBc)                |
| 1-carrier W-CDMA | 2110 to 2200 | 28              | 56                 | 17.0           | 47.0           | -29.6 <sup>[1]</sup> |

<sup>[1]</sup> Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 9.6 dB at 0.01 % probability on CCDF.

#### 1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent digital pre-distortion capability
- Internally matched for ease of use
- Integrated ESD protection
- For RoHS compliance see the product details on the Ampleon website

### 1.3 Applications

 RF power amplifiers for base stations and multi carrier applications in the 2110 MHz to 2200 MHz frequency range

# 2. Pinning information

Table 2. Pinning

| Pin | Description             |     | Simplified outline | Graphic symbol     |
|-----|-------------------------|-----|--------------------|--------------------|
| 1   | drain2 (peak)           |     |                    | 0.7                |
| 2   | drain1 (main)           |     | 7 2 1 6            | 2,7                |
| 3   | gate1 (main)            |     | 5                  |                    |
| 4   | gate2 (peak)            |     | 3 4                | 3——5               |
| 5   | source                  | [1] |                    | 4—                 |
| 6   | video decoupling (peak) |     |                    | " <del>'</del> ¬   |
| 7   | video decoupling (main) |     |                    | 1, 6<br>aaa-014884 |

<sup>[1]</sup> Connected to flange.

# 3. Ordering information

Table 3. Ordering information

| Type number       | Package |  |           |  |  |  |
|-------------------|---------|--|-----------|--|--|--|
|                   | Name    | Description  | Version   |  |  |  |
| BLC10G22XS-400AVT | -       | air cavity plastic earless flanged package;<br>6 leads | SOT1258-4 |  |  |  |

# 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol                   | Parameter                          | Conditions    | Min             | Max  | Unit |
|--------------------------|------------------------------------|---------------|-----------------|------|------|
| $V_{DS}$                 | drain-source voltage               |               | -               | 65   | V    |
| V <sub>GS(amp)main</sub> | main amplifier gate-source voltage |               | -6              | +9   | V    |
| V <sub>GS(amp)peak</sub> | peak amplifier gate-source voltage |               | -6              | +9   | V    |
| T <sub>stg</sub>         | storage temperature                |               | -65             | +150 | °C   |
| Tj                       | junction temperature               | [1]           | -               | 225  | °C   |
| T <sub>case</sub>        | case temperature                   | operating [1] | <del>-4</del> 0 | +125 | °C   |

<sup>[1]</sup> Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

# 5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol               | Parameter                                | Conditions  | Тур  | Unit |
|----------------------|--|---|------|------|
| R <sub>th(j-c)</sub> | thermal resistance from junction to case | V <sub>DS</sub> = 28 V; I <sub>Dq</sub> = 800 mA (main);<br>V <sub>GS(amp)peak</sub> = 1.0 V; T <sub>case</sub> = 80 °C |      |      |
|                      |  | P <sub>L</sub> = 56 W   | 0.29 | k/W  |
|                      |  | P <sub>L</sub> = 74 W   | 0.27 | k/W  |

BLC10G22XS-400AVT

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### 6. Characteristics

 Table 6.
 DC characteristics

 $T_i$  = 25 °C unless otherwise specified.

| Symbol               | Parameter                        | Conditions   | Min | Тур  | Max | Unit |
|----------------------|----------------------------------|--|-----|------|-----|------|
| Main dev             | rice                             |  |     |      |     |      |
| V <sub>(BR)DSS</sub> | drain-source breakdown voltage   | $V_{GS} = 0 \text{ V}; I_D = 1.44 \text{ mA}$                      | 65  | -    | -   | V    |
| V <sub>GS(th)</sub>  | gate-source threshold voltage    | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 144 mA                    | 1.5 | 2.0  | 2.5 | V    |
| $V_{GSq}$            | gate-source quiescent voltage    | V <sub>DS</sub> = 28 V; I <sub>D</sub> = 800 mA                    | -   | 2.2  | -   | V    |
| I <sub>DSS</sub>     | drain leakage current            | V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 32 V                      | -   | -    | 2.8 | μΑ   |
| I <sub>DSX</sub>     | drain cut-off current            | $V_{GS} = V_{GS(th)} + 3.75 \text{ V}$                             | -   | 26.5 | -   | Α    |
| I <sub>GSS</sub>     | gate leakage current             | V <sub>GS</sub> = 9 V; V <sub>DS</sub> = 0 V                       | -   | -    | 280 | nA   |
| 9 <sub>fs</sub>      | forward transconductance         | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 7.2 A                     | -   | 15.0 | -   | S    |
| R <sub>DS(on)</sub>  | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$<br>$I_D = 5.04 \text{ A}$  | -   | 93   | 128 | mΩ   |
| Peak dev             | rice                             |  |     |      | 1   |      |
| V <sub>(BR)DSS</sub> | drain-source breakdown voltage   | $V_{GS} = 0 \text{ V}; I_D = 2.98 \text{ mA}$                      | 65  | -    | -   | V    |
| V <sub>GS(th)</sub>  | gate-source threshold voltage    | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 298 mA                    | 1.5 | 2.0  | 2.5 | V    |
| $V_{GSq}$            | gate-source quiescent voltage    | V <sub>DS</sub> = 28 V; I <sub>D</sub> = 1600 mA                   | -   | 2.2  | -   | V    |
| I <sub>DSS</sub>     | drain leakage current            | V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 32 V                      | -   | -    | 2.8 | μΑ   |
| I <sub>DSX</sub>     | drain cut-off current            | $V_{GS} = V_{GS(th)} + 3.75 \text{ V}$                             | -   | 47   | -   | Α    |
| I <sub>GSS</sub>     | gate leakage current             | V <sub>GS</sub> = 11 V; V <sub>DS</sub> = 0 V                      | -   | -    | 280 | nA   |
| g <sub>fs</sub>      | forward transconductance         | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 14.9 A                    | -   | 28.5 | -   | S    |
| R <sub>DS(on)</sub>  | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$<br>$I_D = 10.43 \text{ A}$ | -   | 50   | 74  | mΩ   |

#### Table 7. RF characteristics

Test signal: 1-carrier W-CDMA; PAR = 9.6 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1 to 64 DPCH;  $f_1$  = 2112.5 MHz;  $f_2$  = 2167.5 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 800 mA (main);  $V_{GS(amp)peak}$  = 1.0 V;  $T_{case}$  = 25 °C; unless otherwise specified; in an asymmetrical Doherty production test circuit at frequencies from 2110 MHz to 2200 MHz.

| Symbol         | Parameter                    | Conditions                | Min  | Тур  | Max | Unit |
|----------------|------------------------------|---------------------------|------|------|-----|------|
| G <sub>p</sub> | power gain                   | P <sub>L(AV)</sub> = 56 W | 15.3 | 16.3 | -   | dB   |
| RLin           | input return loss            | P <sub>L(AV)</sub> = 56 W | -    | -14  | -9  | dB   |
| $\eta_{D}$     | drain efficiency             | P <sub>L(AV)</sub> = 56 W | 42   | 46   | -   | %    |
| ACPR           | adjacent channel power ratio | P <sub>L(AV)</sub> = 56 W | -    | -29  | -24 | dBc  |

#### Table 8. RF characteristics

Test signal: 1-carrier W-CDMA; PAR = 9.6 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1 to 64 DPCH;  $f_1$  = 2112.5 MHz;  $f_2$  = 2167.5 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 800 mA (main);  $V_{GS(amp)peak}$  = 1.0 V;  $T_{case}$  = 25 °C; unless otherwise specified; in an asymmetrical Doherty production test circuit at a frequency of 2200 MHz.

| Symbol     | Parameter                    | Conditions                | Min | Тур | Max | Unit |
|------------|------------------------------|---------------------------|-----|-----|-----|------|
| PARO       | output peak-to-average ratio | P <sub>L(AV)</sub> = 56 W | 6.3 | 6.9 | -   | dB   |
| $P_{L(M)}$ | peak output power            | P <sub>L(AV)</sub> = 56 W | 380 | 440 | -   | W    |

BLC10G22XS-400AVT

**Product data sheet** 

# 7. Test information

## 7.1 Ruggedness in Doherty operation

The BLC10G22XS-400AVT is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 32 V;  $I_{Dq}$  = 800 mA;  $V_{GS(amp)peak}$  = 1.0 V; f = 2112.5 MHz;  $P_{L}$  = 155 W (5 dB OBO); 100 % clipping

## 7.2 Impedance information

 Table 9.
 Typical impedance of main device

Measured load-pull data of main device;  $I_{Dq}$  = 800 mA (main);  $V_{DS}$  = 28 V; pulsed CW ( $t_p$  = 100  $\mu$ s;  $\delta$  = 10 %).

| f       | Z <sub>S</sub> [1]  | Z <sub>L</sub> [1] | P <sub>L</sub> [2] | η <sub>D</sub> [2] | G <sub>p</sub> [2] |
|---------|---------------------|--------------------|--------------------|--------------------|--------------------|
| (MHz)   | <b>(</b> Ω <b>)</b> | <b>(Ω)</b>         | (W)                | (%)                | (dB)               |
| Maximun | n power load        |                    |                    |                    |                    |
| 2110    | 1.6 – j6.1          | 1.5 – j2.9         | 205                | 61.5               | 17.2               |
| 2140    | 2.1 – j6.5          | 1.5 – j2.9         | 205                | 62.0               | 17.3               |
| 2170    | 2.6 - j7.0          | 1.4 – j3.3         | 205                | 60.0               | 17.2               |
| Maximun | n drain efficiency  | load               |                    |                    |                    |
| 2110    | 1.6 – j6.1          | 2.4 – j2.4         | 160                | 68.0               | 19.1               |
| 2140    | 2.1 – j6.5          | 2.4 – j2.3         | 158                | 67.5               | 19.2               |
| 2170    | 2.6 – j7.0          | 2.0 – j2.2         | 160                | 67.0               | 19.1               |

<sup>[1]</sup>  $Z_S$  and  $Z_L$  defined in Figure 1.

<sup>[2]</sup> At 3 dB gain compression.

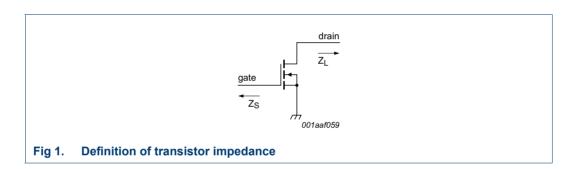
Table 10. Typical impedance of peak device

Measured load-pull data of peak device;  $I_{Dq}$  = 1600 mA (peak);  $V_{DS}$  = 28 V; pulsed CW ( $t_p$  = 100  $\mu$ s;  $\delta$  = 10 %).

| f       | Z <sub>S</sub> [1] | Z <sub>L</sub> [1] | P <sub>L</sub> [2] | η <sub>D</sub> [2] | G <sub>p</sub> [2] |
|---------|--------------------|--------------------|--------------------|--------------------|--------------------|
| (MHz)   | (Ω)                | (Ω)                | (W)                | (%)                | (dB)               |
| Maximum | power load         |                    |                    |                    |                    |
| 2110    | 1.9 – j5.4         | 1.3 – j3.3         | 390                | 60.0               | 16.2               |
| 2140    | 2.4 – j5.7         | 1.4 – j3.5         | 390                | 57.5               | 16.3               |
| 2170    | 3.1 – j6.1         | 1.3 – j3.7         | 390                | 55.0               | 16.1               |
| Maximum | n drain efficiency | load               |                    |                    |                    |
| 2110    | 1.9 – j5.4         | 1.8 – j2.7         | 340                | 63.6               | 17.6               |
| 2140    | 2.4 – j5.7         | 1.9 – j2.6         | 315                | 63.4               | 18.1               |
| 2170    | 3.1 – j6.1         | 1.9 – j2.7         | 320                | 63.6               | 18.2               |

<sup>[1]</sup>  $Z_S$  and  $Z_L$  defined in Figure 1.

<sup>[2]</sup> At 3 dB gain compression.



## 7.3 Recommended impedances for Doherty design

#### Table 11. Typical impedance of main at 1:1 load

Measured load-pull data of main device;  $I_{Dq}$  = 800 mA (main);  $V_{DS}$  = 28 V; pulsed CW ( $t_p$  = 100  $\mu$ s;  $\delta$  = 10 %).

| f     | Z <sub>S</sub> [1]  | Z <sub>L</sub> [1]  | P <sub>L</sub> [2] | η <sub>D</sub> [2] | G <sub>p</sub> [2] |
|-------|---------------------|---------------------|--------------------|--------------------|--------------------|
| (MHz) | <b>(</b> Ω <b>)</b> | <b>(</b> Ω <b>)</b> | (W)                | (%)                | (dB)               |
| 2110  | 1.7 – j5.5          | 2.1 – j3.8          | 165                | 38.0               | 20.8               |
| 2140  | 2.0 – j5.8          | 2.1 – j3.5          | 170                | 38.0               | 20.8               |
| 2170  | 2.3 – j6.1          | 2.0 - j3.3          | 175                | 38.5               | 21.1               |

<sup>[1]</sup>  $Z_S$  and  $Z_L$  defined in Figure 1.

<sup>[2]</sup> At  $P_{L(AV)} = 56 \text{ W}$ .

Table 12. Typical impedance of main device at 1: 2.5 load

Measured load-pull data of main device;  $I_{Dq}$  = 800 mA (main);  $V_{DS}$  = 28 V; pulsed CW ( $t_p$  = 100  $\mu$ s;  $\delta$  = 10 %).

| f     | Z <sub>S</sub> [1]  | Z <sub>L</sub> [1]  | P <sub>L</sub> [2] | η <sub>D</sub> [2] | G <sub>p</sub> [2] |
|-------|---------------------|---------------------|--------------------|--------------------|--------------------|
| (MHz) | <b>(</b> Ω <b>)</b> | <b>(</b> Ω <b>)</b> | (W)                | (%)                | (dB)               |
| 2110  | 1.7 – j5.5          | 3.6 – j0.8          | 85                 | 53.2               | 23.5               |
| 2140  | 2.0 – j5.8          | 3.5 – j0.6          | 78                 | 53.4               | 23.5               |
| 2170  | 2.3 – j6.1          | 3.3 – j0.4          | 70                 | 53.2               | 24.0               |

<sup>[1]</sup>  $Z_S$  and  $Z_L$  defined in Figure 1.

#### Table 13. Typical impedance of peak device at 1:1 load

Measured load-pull data of peak device;  $I_{Dq}$  = 1600 mA (peak);  $V_{DS}$  = 28 V; pulsed CW ( $t_p$  = 100  $\mu$ s;  $\delta$  = 10 %).

| f     | Z <sub>S</sub> [1]  | Z <sub>L</sub> [1]  | P <sub>L</sub> [2] | η <sub>D</sub> [2] | G <sub>p</sub> [2] |
|-------|---------------------|---------------------|--------------------|--------------------|--------------------|
| (MHz) | <b>(</b> Ω <b>)</b> | <b>(</b> Ω <b>)</b> | (W)                | (%)                | (dB)               |
| 2110  | 1.7 – j4.8          | 1.8 – j3.5          | 350                | 25.5               | 19.7               |
| 2140  | 2.0 - j5.0          | 1.8 – j3.2          | 345                | 25.8               | 19.9               |
| 2170  | 2.4 – j5.2          | 1.8 – j3.1          | 340                | 26.4               | 20.4               |

<sup>[1]</sup>  $Z_S$  and  $Z_L$  defined in Figure 1.

Table 14. Off-state impedances of peak device

| f     | Z <sub>off</sub> |
|-------|------------------|
| (MHz) | (Ω)              |
| 2110  | 2.9 – j2.9       |
| 2140  | 2.3 – j1.8       |
| 2170  | 2.0 – j1.0       |

<sup>[2]</sup> At  $P_{L(AV)} = 56 \text{ W}$ .

<sup>[2]</sup> At  $P_{L(AV)} = 56 \text{ W}$ .

## 7.4 Test circuit

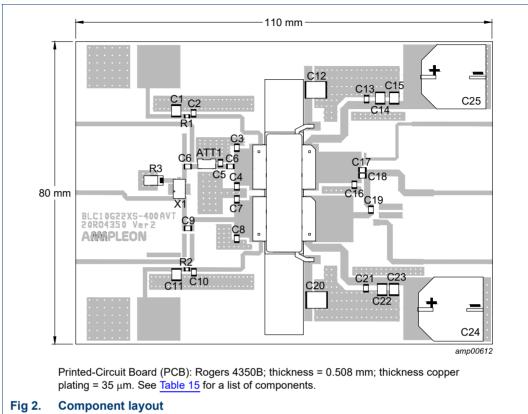
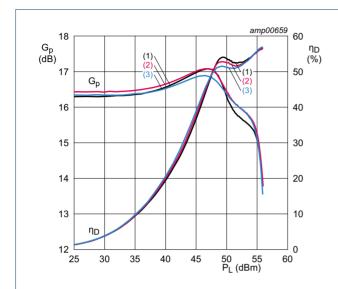


Table 15. List of components See Figure 2 for component layout.

| Component                         | Description                       | Value         | Remarks                              |
|-----------------------------------|-----------------------------------|---------------|--------------------------------------|
| C1, C11, C14, C15,<br>C22, C23,   | multilayer ceramic chip capacitor | 10 μF, 50 V   | Murata: GRM32ER71H106KA12L, SMD 1210 |
| C2, C6, C9, C10, C13,<br>C19, C21 | multilayer ceramic chip capacitor | 15 pF, 250 V  | Murata: GQM2195C2E150FB15, SMD 805   |
| C3, C4, C7, C8                    | multilayer ceramic chip capacitor | 1.0 pF, 250 V | Murata: GQM2195C2E1ROBB15, SMD 0805  |
| C5                                | multilayer ceramic chip capacitor | 0.8 pF, 250 V | Murata: GQM2195C2E1ROBB15, SMD 0805  |
| C12, C20                          | multilayer ceramic chip capacitor | 4.7 μF, 100 V | C5750X7R2A475KT/A                    |
| C16                               | multilayer ceramic chip capacitor | 0.5 pF, 250 V | Murata: GQM2195C2E1ROBB15, SMD 0805  |
| C17, C18                          | multilayer ceramic chip capacitor | 1.8 pF, 250 V | Murata: GQM2195C2E1R8BB15, SMD 0805  |
| C24, C25                          | electrolytic capacitor            | 470 μF, 63 V  |                                      |
| R1, R2                            | resistor                          | 5.1 Ω, 1 %    | SMD 805                              |
| R3                                | resistor                          | 50 Ω, 25 W    | Anaren: C16A50Z4                     |
| X1                                | hybrid coupler                    | 2 dB, 90°     | Anaren: Xinger III, X3C20F1-02       |
| ATT1                              | attenuator                        | 1 dB          | Anaren: D10AA1Z4                     |

### 7.5 Graphical data

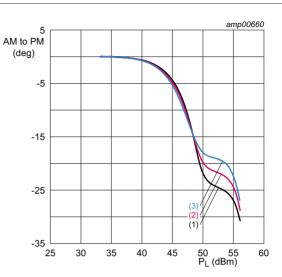
### 7.5.1 Pulsed CW



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 800 mA;  $V_{GS(amp)peak}$  = 1.0 V.

- (1) f = 2210 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

Fig 3. Power gain and drain efficiency as function of output power; typical values



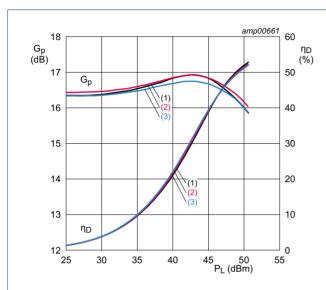
 $V_{DS}$  = 28 V;  $I_{Dq}$  = 800 mA;  $V_{GS(amp)peak}$  = 1.0 V.

- (1) f = 2210 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

Fig 4. Normalized AM to PM as a function of output power; typical values

#### 7.5.2 1-Carrier W-CDMA

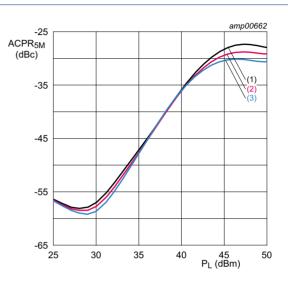
Test signal: 3GPP test model 1; 1 to 64 DPCH (100 % clipping): PAR = 7.5 dB per carrier at 0.01 % probability on CCDF per carrier.



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 800 mA;  $V_{GS(amp)peak}$  = 1.0 V.

- (1) f = 2210 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

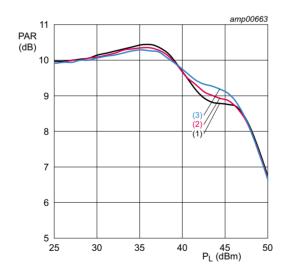
Fig 5. Power gain and drain efficiency as function of output power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 800 mA;  $V_{GS(amp)peak}$  = 1.0 V.

- (1) f = 2210 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

Fig 6. Adjacent channel power ratio (5 MHz) as a function of output power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 800 mA;  $V_{GS(amp)peak}$  = 1.0 V.

- (1) f = 2210 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

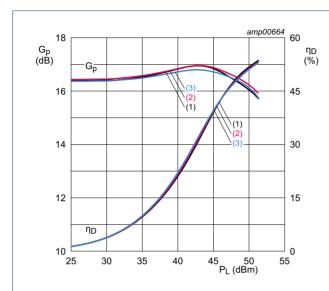
Fig 7. Peak-to-average power ratio as a function of output power; typical values

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#### 7.5.3 2-Carrier W-CDMA

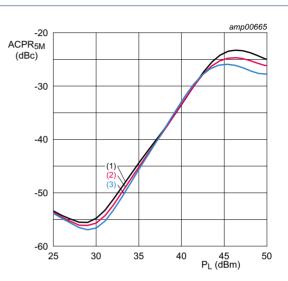
Test signal: 3GPP test model 1; 1 to 64 DPCH (46 % clipping): PAR = 7.5 dB per carrier at 0.01 % probability on CCDF per carrier.



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 800 mA;  $V_{GS(amp)peak}$  = 1.0 V.

- (1) f = 2210 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

Fig 8. Power gain and drain efficiency as function of output power; typical values

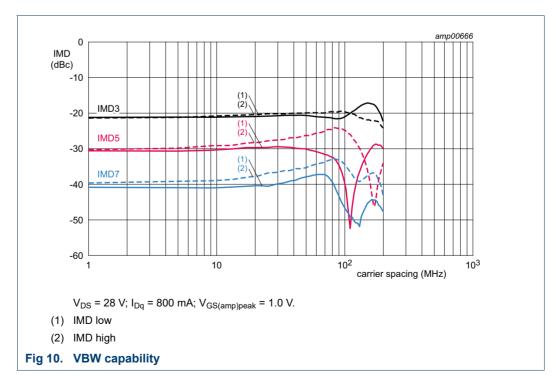


 $V_{DS}$  = 28 V;  $I_{Dq}$  = 800 mA;  $V_{GS(amp)peak}$  = 1.0 V.

- (1) f = 2210 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

Fig 9. Adjacent channel power ratio (5 MHz) as a function of output power; typical values

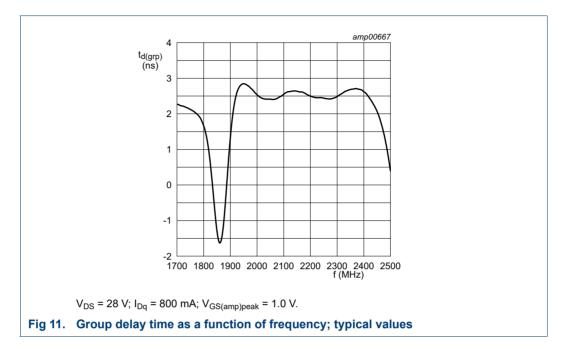
#### 7.5.4 2-Tone VBW



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### 7.5.5 Group delay



# 8. Package outline

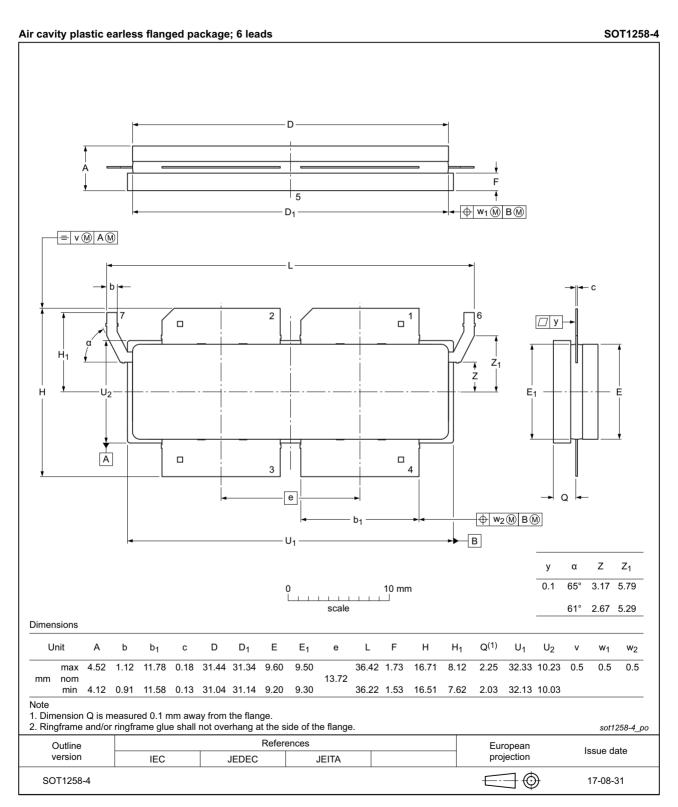


Fig 12. Package outline SOT1258-4

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# 9. Handling information

#### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 16. ESD sensitivity

| ESD model  | Class  |
|--|--------|
| Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002 | C3 [1] |
| Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001     | 2 [2]  |

- [1] CDM classification C3 is granted to any part that passes after exposure to an ESD pulse of 1000 V.
- [2] HBM classification 2 is granted to any part that passes after exposure to an ESD pulse of 2000 V, but fails after exposure to an ESD pulse of 4000 V.

### 10. Abbreviations

Table 17. Abbreviations

| Acronym | Description                                    |
|---------|--|
| 3GPP    | 3rd Generation Partnership Project             |
| CCDF    | Complementary Cumulative Distribution Function |
| CW      | Continuous Wave                                |
| DPCH    | Dedicated Physical CHannel                     |
| ESD     | ElectroStatic Discharge                        |
| LDMOS   | Laterally Diffused Metal-Oxide Semiconductor   |
| MTF     | Median Time to Failure                         |
| ОВО     | Output Back Off                                |
| PAR     | Peak-to-Average Ratio                          |
| RoHS    | Restriction of Hazardous Substances            |
| SMD     | Surface Mounted Device                         |
| VSWR    | Voltage Standing Wave Ratio                    |
| W-CDMA  | Wideband Code Division Multiple Access         |

# 11. Revision history

Table 18. Revision history

| Document ID           | Release date | Data sheet status  | Change notice | Supersedes |
|-----------------------|--------------|--------------------|---------------|------------|
| BLC10G22XS-400AVT v.1 | 20180430     | Product data sheet | -             | -          |

# 12. Legal information

#### 12.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.ampleon.com.

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BLC10G22XS-400AVT

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# BLC10G22XS-400AVT

#### **Power LDMOS transistor**

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# **AMPLEON**

# **BLC10G22XS-400AVT**

#### **Power LDMOS transistor**

# 14. Contents

| Product profile                             |
|---|
| General description                         |
| Features and benefits                       |
| Applications                                |
| Pinning information 2                       |
| Ordering information                        |
| Limiting values                             |
| Thermal characteristics 2                   |
| Characteristics                             |
| Test information 4                          |
| Ruggedness in Doherty operation 4           |
| Impedance information 4                     |
| Recommended impedances for Doherty design 5 |
| Test circuit                                |
| Graphical data 8                            |
| Pulsed CW                                   |
| 1-Carrier W-CDMA 9                          |
| 2-Carrier W-CDMA                            |
| 2-Tone VBW                                  |
| Group delay 11                              |
| Package outline                             |
| Handling information                        |
| Abbreviations                               |
| Revision history                            |
| Legal information                           |
| Data sheet status                           |
| Definitions                                 |
| Disclaimers                                 |
| Trademarks15                                |
| Contact information                         |
| Contents                                    |
|   |

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